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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Ching-Wen Hung	04/25/2013
Chih-Sen Huang	04/25/2013

RECEIVING PARTY DATA

Name:	UNITED MICROELECTRONICS CORP.
Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park
City:	Hsin-Chu City
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13875293

CORRESPONDENCE DATA

Fax Number: 7039974517

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 3027291562

Email: Patent.admin.uspto.cr@naipo.com

Correspondent Name: WINSTON HSU
Address Line 1: P.O.BOX 506

Address Line 4: Merrifield, VIRGINIA 22116

NAUP1622USA
SHELLEY KUO
/SHELLEY KUO/
05/02/2013

Total Attachments: 4

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> PATENT REEL: 030331 FRAME: 0282

CH \$40.00 138752

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention:

SEMICONDUCTOR STRUCTURE AND MANUFACTURING METHOD THEREOF

As the below named inventor, I here This declaration is directed to:	eby declare that:			
☑ The attached application, or	r			
☐ United States application number			_filed on, or	
☐ PCT international application		filed on		
The above-identified application was	s made or authorized	to be made by me.		111111111111111111111111111111111111111
I believe that I am the original invent application.	tor or an original joint	inventor of a claime	ed invention in th	ne
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impr	Il false statement mad isonment of not more	de in this declaratio than five (5) years	n is punishable or both.	
In consideration of the payment by	UNITED MICROE	LECTRONICS	having a posta	al address of
No.3, Li-Hsin Road 2, Science	e-Based Industria	l Park, Hsin-Chu	_ ı City 300, Та	iwan, R.O.C.
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good are	o I of the sum of One nd valuable considera	Dollar (\$ 1.00), the tion.	receipt of which	is hereby
I hereby sell, assign and transfer to a the entire right, title and interest in a invention as above-identified applica- invention by the above application o substitutes, or extensions thereof, an	nd to any and all impi ation and, in and to, al r any continuations, c	ovements which ar Il Letters Patent to b ontinuation-in-part,	e disclosed in the obtained for some divisions, renew	ie said ⁄als,
I hereby covenant that no assignmentered into which would conflict wit		r encumbrance has	been or will be	made or
I further covenant that ASSIGNEE wand documents relating to said inverknown and accessible to I and will to related thereto and will promptly exe	ntion and said Letters estify as to the same i	Patent and legal ed n any interference,	quivalents as ma litigation procee	ay be
representatives any and all papers, i maintain, issue and enforce said app equivalents thereof which may be no IN WINTNESS WHEREOF, I have h	olication, said inventic ecessary or desirable	on and said Letters to carry out the pro	Patent and said poses thereof.	Date of signing)
Note: An application data sheet (PTo inventive entity, must accompany this				

Page 1 of 4

NPO#NAU-P1622-USA:0 CUST#UMCD-2012-0430 F#NPO-P0002E-US1201 DSC0-102U001135

Docket No NAUP1622USA

Inventor: Ching-Wen Hung

Signature: Ching - Wen Hung

Ching - Wen Hung

Ching - Wen Hung

Page 2 of 4

NPO#NAU-P1622-USA:0 CUST#UMCD-2012-0430 F#NPO-P0002E-US1201 DSC0-102U001135

PATENT REEL: 030331 FRAME: 0284

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention:

SEMICONDUCTOR STRUCTURE AND MANUFACTURING METHOD THEREOF

As the below named inventor, I here This declaration is directed to:	by declare that:			•	
☑ The attached application, or					
☐ United States application number		fil	ed on	, or	
☐ PCT international application number			filed on		
The above-identified application was	made or authorized	to be made by	me.		
I believe that I am the original invente application.	or or an original join	t inventor of a cla	aimed invention in	the	
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impri	I false statement ma isonment of not mor	ade in this declar e than five (5) ye	ation is punishable ears, or both.	9	
In consideration of the payment by	UNITED MICRO CORP.	ELECTRONIC	s having a po	stal address of	
No.3, Li-Hsin Road 2, Science	-Based Industria	al Park, Hsin-	Chu City 300, 7	aiwan, R.O.C.	
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good an	ol of the sum of One d valuable consider	e Dollar (\$ 1.00), ation.	the receipt of whi	ch is hereby	
I hereby sell, assign and transfer to A the entire right, title and interest in ar invention as above-identified applica- invention by the above application or substitutes, or extensions thereof, ar	nd to any and all imp tion and, in and to, a rany continuations,	provements whic all Letters Patent continuation-in-p	h are disclosed in to be obtained fo part, divisions, rene	the r said ewals,	
I hereby covenant that no assignmer entered into which would conflict with	nt, sale, agreement on this assignment;	or encumbrance	has been or will b	e made or	
I further covenant that ASSIGNEE w and documents relating to said inven known and accessible to I and will te related thereto and will promptly exec	tion and said Letter stify as to the same	s Patent and legation in any interferen	al equivalents as r ice, litigation proce	may be	
representatives any and all papers, in maintain, issue and enforce said app equivalents thereof which may be ne IN WINTNESS WHEREOF, I have he	lication, said inventi cessary or desirable	on and said Lette to carry out the	ers Patent and sa	id (Date of signing)	
Note: An application data sheet (PTC inventive entity, must accompany this					

Page 3 of 4

NPO#NAU-P1622-USA:0 CUST#UMCD-2012-0430

F#NPO-P0002E-US1201 DSC0-102U001135

Docket No NAUP1622USA

Inventor: Chih-Sen Huang Date: APR 2 5 2013

NPO#NAU-P1622-USA:0 CUST#UMCD-2012-0430 Page 4 of 4

F#NPO-P0002E-US1201 DSC0-102U001135

PATENT REEL: 030331 FRAME: 0286

RECORDED: 05/02/2013